MEG01-002 Serial number 09/783,384

BEST AVAILABLE COPY



TECHNOLOGY CENTER 2800



TO: COMMISSIONER OF PATENTS AND TRADEMARKS

Washington, D.C. 20231

From: George O. Saile (Reg. No. 19,572)

28 Davis Avenue

Poughkeepsie, NY 12603

February 17, 2003 Date:

EXAMINER

: Ching-Cheng Huang REF: APPLICANT

> : 09/783,384 SERIAL NO.

ART UNIT : 2823

FILING DATE: 02/15/01

ATT'Y NO. : MEG01-002

: Lee, Hsien Ming TITLE : RELIABLE METAL BUMPS

ON TOP OF I/O PADS AFTER REMOVAL

OF TEST PROBE MARKS

AMENDMENT AND RESPONSE TO OFFICE ACTION

Sir:

In response to an office action mailed on 11/26/02please consider the following amendments and remarks with respect to the above referenced application.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal service as First Class mail in an envelop addressed to the Commissioner of Patents and Trademarks, Washington, D.C. 20231, on February 26,2003.

Stephen B. Ackerman (Reg. No 37,761)

Signature